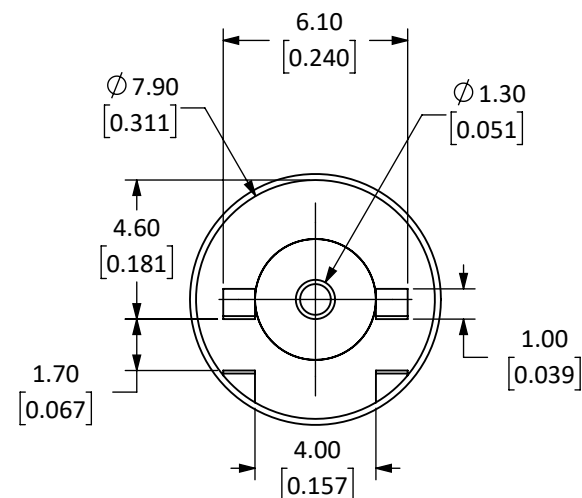
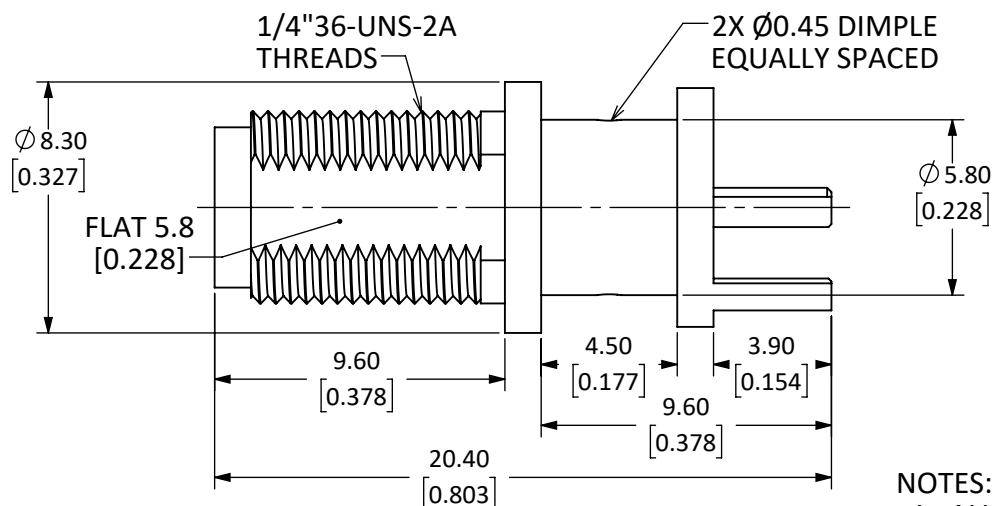


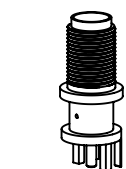
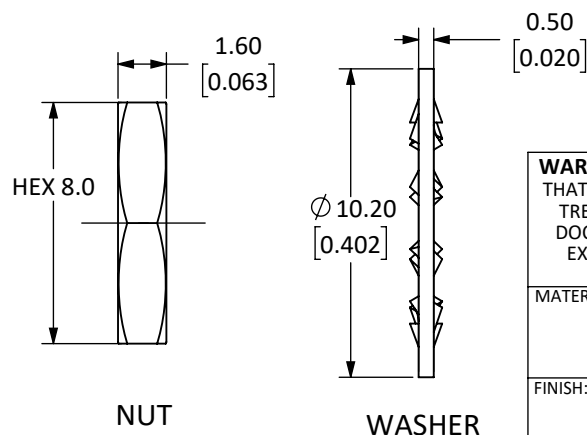
Connector: SMA Jack (Female Socket)			
Termination: PCB Board Edge, End Launch; Panel Mount			
Part Number		CON SMA006.062	CON SMA006.062-G
Connector Part	Material	Finish	Finish
Bodies	Body: Brass	Nickel	Gold
	Nut: Brass	Nickel	Gold
	Washer: Brass	Nickel	Gold
Center Contact	Socket: Be Cu	Gold	Gold
Insulator	PTFE	-	-

REVISIONS			
REV	DESCRIPTION	DATE	APPV
A	INITIAL RELEASE OF LINX INTERNAL DRAWING	01/MAR/19	CLL



NOTES: (UNLESS OTHERWISE SPECIFIED)

1. ALL DIMENSIONS ARE IN mm [INCHES].
2. DIMENSIONS APPLY AFTER FINISHING.
3. MANUFACTURE TO BE COMPLIANT WITH EU RoHS DIRECTIVE, USE MATERIALS THAT DO NOT CONTAIN REACH SUBSTANCES OF VERY HIGH CONCERN >1000ppm, AND USE DRC CONFLICT-FREE SOURCED MATERIALS.
4. SAFETY BREAK ALL SHARP CORNERS AND EDGES 0.5 MAXIMUM.
5. SEE TABLE I FOR ELECTRICAL SPECIFICATIONS. (SHEET 2)
6. SEE TABLE II FOR ENVIRONMENTAL SPECIFICATIONS. (SHEET 2)
7. SEE TABLE III FOR MECHANICAL SPECIFICATIONS. (SHEET 2)
8. SEE PARTSLIST. "*" INDICATES FINISH TYPE.



SCALE 1 : 1

NUT

WASHER

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MATERIAL:	TOLERANCES: 0.50 [0.020]-5.00 [0.200]= ±0.20 [0.008] 5.00 [0.200]-30.00 [1.200]= ±0.40 [0.016] 30.0 [1.20]-120.0 [4.75]= ±0.60 [0.24] 120.0 [4.75]-315.0 [12.40]= ±1.0 [0.040]	PROJECTION:  ANGLES: ±1°
	FINISH:	
	DRAWN: M. SCHULTE	DT: 21/JAN/19
	ENGR: D. VARATHARAJAN	DT: 08/MAR/19

Linx

159 ORT LANE
MERLIN, OR 97532

TITLE:
**SMA FEMALE EDGE MULTI-MOUNT
FOR 0.062" THICK BOARD**

SIZE	DWG. NO.	REV
A	CON SMA006.062-*	A
SCALE: 4:1	DO NOT SCALE DRAWING	SHEET 1 OF 2

5 TABLE I

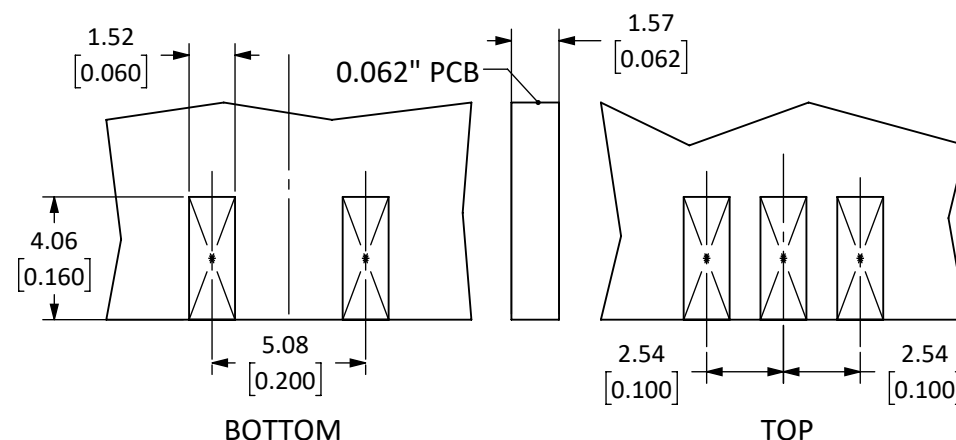
Electrical Data	Detail
Impedance	50 Ω
Frequency Range	0 to 18 GHz
Insulation Resistance	—
Voltage Rating	500 V RMS
Contact Resistance	Center: ≤ 2.0 m Ω Outer: ≤ 2.0 m Ω
VSWR	$\leq 1.2 : 1$ @ 6 GHz

6 TABLE II

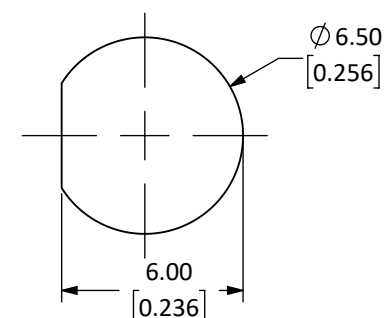
Environmental Data	Detail
Corrosion (Salt spray)	ASTM B-117
Thermal Shock	MIL-STD-202 Method 107 test condition B
Vibration	MIL-STD-202 Method 204 test condition D
Mechanical Shock	MIL-STD-202 Method 213 test condition I
Temperature Range	-65 °C to +165 °C
Environmental Compliance	RoHS

7 TABLE III

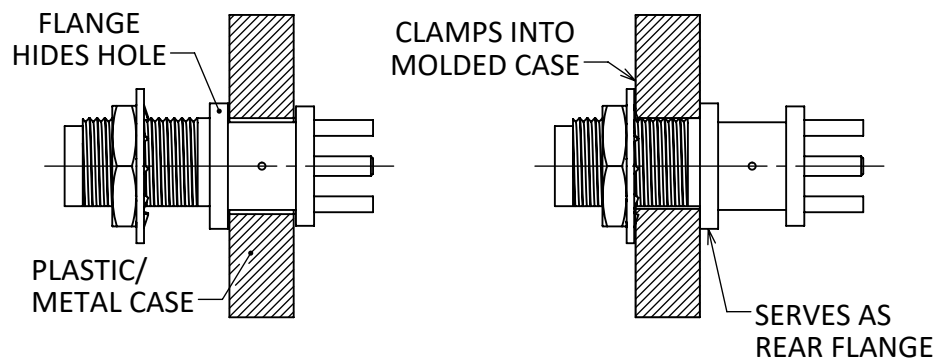
Mechanical Data	Detail
Mounting Type	PCB Board Edge, End Launch; Panel Mount
Fastening Type	1/4"-36 Threaded Coupling
Interface In Accordance With	MIL-STD 348A
Recommended Torque	0.57 N·m (5.0 in·lbs)
Coupling Nut Retention	60 lbs. min.
Connector Durability	500 cycles min.
Weight	3.4 g (0.12 oz)



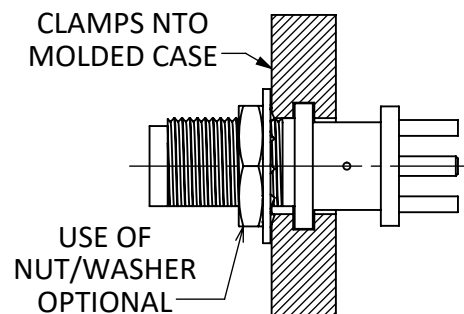
RECOMMENDED FOOTPRINT



RECOMMENDED MOUNTING HOLE



MOUNTING METHODS



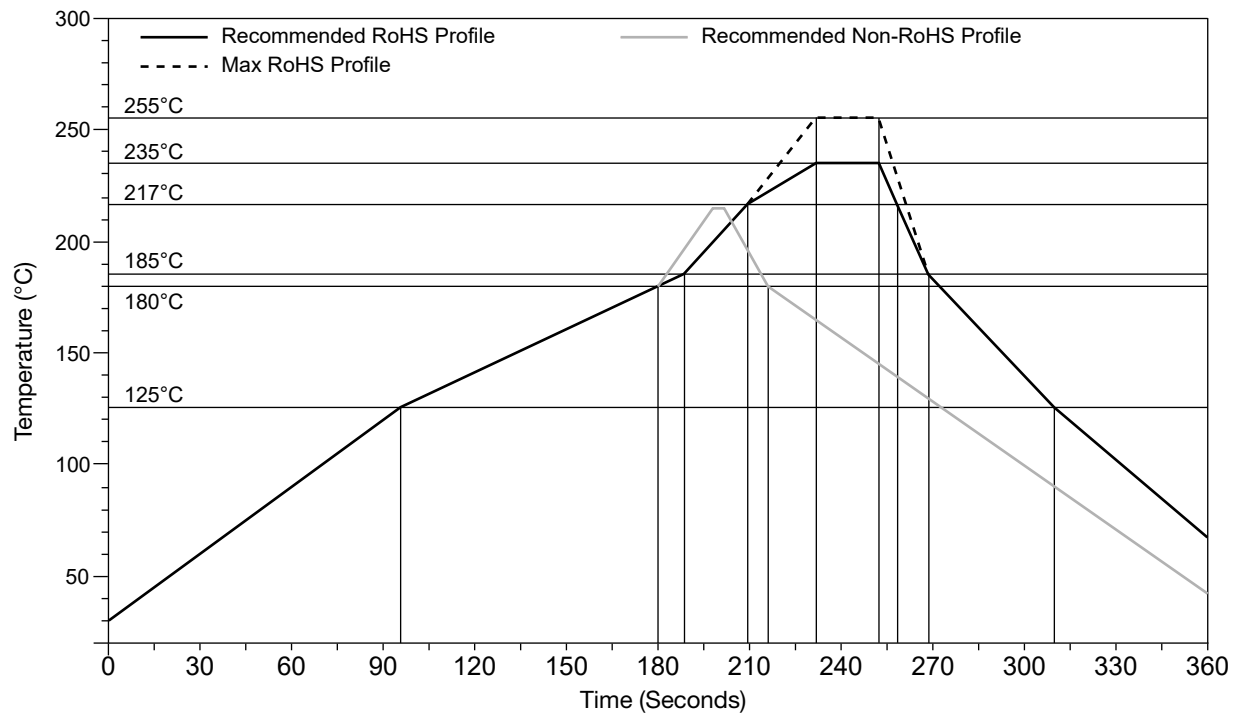
SIZE	DWG. NO.	REV
A	CONSMA006.062-*	A
SCALE: 4:1	DO NOT SCALE DRAWING	SHEET 2 OF 2

Reflow Soldering

Reflow soldering is the most common method of attaching surface mount electronic components to a circuit board. The goal of the reflow process is to melt the solder and heat the conductive surfaces, without overheating or damaging any electrical components. In the conventional reflow soldering process, there are four distinct stages, or zones, having specific thermal profiles: preheat, thermal soak, reflow, and cooling. For high-volume assembly, surface mount components are generally auto-placed by machine.

Reflow Temperature Profile

The single most critical stage in the automated assembly process is the reflow stage. The reflow profile for any given component should be closely followed because excessive temperatures or transport times during reflow can irreparably damage the component. Assembly personnel need to pay careful attention to the oven's profile to ensure that it meets the requirements necessary to successfully reflow all components while still remaining within the limits mandated by components requiring shorter flow periods.



Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
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Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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